



01-77/

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As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

COMPLEMENTARY MOS SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME

the specification of which (check one); ☐ is attached hereto; ☒ was filed on AUGUST 31, 2001 as Application Serial No. 09/944,365 and was amended on (or amended through) _____ (if applicable). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above. I acknowledge the duty to disclose information which is material to patentability in accordance with Title 37, Code of Federal Regulations, §1.56(a). I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)

			Priority Claimed	
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No
2000-265495	Japan	01/09/2000	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2000-299549	Japan	29/09/2000	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2000-331080	Japan	30/10/2000	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2001-035800	Japan	13/02/2001	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2001-044068	Japan	20/02/2001	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2001-113049	Japan	11/04/2001	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2001-118539	Japan	17/04/2001	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2001-188051	Japan	21/06/2001	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2001-204758	Japan	05/07/2001	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2001-241293	Japan	08/08/2001	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2001-241294	Japan	08/08/2001	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2001-241297	Japan	08/08/2001	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2001-241298	Japan	08/08/2001	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2001-241299	Japan	08/08/2001	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2001-241829	Japan	09/08/2001	<input checked="" type="checkbox"/>	<input type="checkbox"/>
2001-243944	Japan	10/08/2001	<input checked="" type="checkbox"/>	<input type="checkbox"/>

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.) (Filing Date) (Status - Patented, Pending or Abandoned)

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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POWER OF ATTORNEY

I (we) hereby appoint Bruce L. Adams, Registration No. 25,386, Van C. Wilks, Registration No. 25,027 and Franco S. De Liguori, Registration No. 36,497 whose post office address is: Adams & Wilks, 50 Broadway, 31st Floor, New York, New York 10004, as my (our) attorneys with full power of substitution and revocation, to prosecute this application, and to transact all business in the United States Patent and Trademark Office connected therewith.

Full Name of First or Sole Inventor	Citizenship
Jun OSANAI	Japan
RESIDENCE Address - Street c/o SEIKO INSTRUMENTS INC. 8, Nakase 1-chome, Mihama-ku	POST OFFICE Address - Street same as residence address
City (Zip) Chiba-shi, Chiba	City (Zip)
State or Country Japan	State or Country
Date October 10, 2001	Signature <i>Jun Osanai</i>
Second Joint Inventor, if any	Citizenship
Hisashi HASEGAWA	Japan
RESIDENCE Address - Street c/o SEIKO INSTRUMENTS INC. 8, Nakase 1-chome, Mihama-ku	POST OFFICE Address - Street same as residence address
City (Zip) Chiba-shi, Chiba	City (Zip)
State or Country Japan	State or Country
Date October 10, 2001	Signature <i>Hisashi Hasegawa</i>
Third Joint Inventor, if any	Citizenship
Sumio KOIWA	Japan
RESIDENCE Address - Street c/o SEIKO INSTRUMENTS INC. 8, Nakase 1-chome, Mihama-ku	POST OFFICE Address - Street same as residence address
City (Zip) Chiba-shi, Chiba	City (Zip)
State or Country Japan	State or Country
Date October 10, 2001	Signature <i>Sumio Koiwa</i>
Fourth Joint Inventor, if any	Citizenship
Kazutoshi ISHII	Japan
RESIDENCE Address - Street c/o SEIKO INSTRUMENTS INC. 8, Nakase 1-chome, Mihama-ku	POST OFFICE Address - Street same as residence address
City (Zip) Chiba-shi, Chiba	City (Zip)
State or Country Japan	State or Country
Date October 10, 2001	Signature <i>Kazutoshi Ishii</i>

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